Equipment Information Sheet

Class 2 Photolithography Hot Plates

Manager: Giovanni Sartorello 607-254-4853 Calls to staff phones will be automatically forwarded to Backup: Tom Pennell 607-254-4309

their cell phones during accessible hours. At other times leave a message or send them an email.

SAFETY

• Surfaces can be hot.

USAGE RESTRICTIONS

• General photolithography training (online and in-person) is required to use this tool.

SCHEDULING/SIGN-UP RESTRICTIONS

Minimum Tool Time: 0 minutes

- A group may have no more than 2 hotplates in simultaneous operation.
- The three numbered Fairweather hot plates must be reserved and enabled in Nemo.

MATERIALS COMPATIBILITY CATEGORY

Tool Category 5: Class A and B Metals and Compounds

Allowed	Not Allowed
Tool category 1/1E, 2, 3, and 4 materials	
Silicon Based Substrates and Films	
III/V compound Semiconductors	
Glass Substrates	
PECVD and ALD Films	
Cured organics and baked Photoresist	
CNF Class A, B, and Refractory metals	
Exposed Gold, Silver, Copper	
Alkali and Alkaline Compounds	
Organic/Biology Molecules prepared- w/salt buffers	
High Vapor Pressure Materials (Mg, Ca, Zn)*	* Some tool restrictions on high vapor pressure materials may apply
Soft organic materials	

High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.

Additional Material Restrictions and Exceptions

- Class 2 materials only (SU-8, LOR, PGMI, LOL, KMPR, OmniCoat, Polyimide).
- The backside of all substrates must be inspected and cleaned prior to baking.

Last Updated: 03/21/2025